SST2222A / UM2222AU3

NPN Medium Power Transistor (Switching)

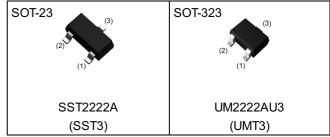
Datasheet

Parameter	Value	
V _{CEO}	40V	
I _C	600mA	

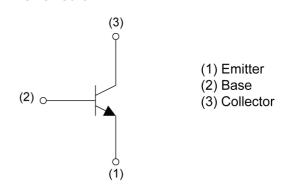
Features

- $1)BV_{CEO}>40V(I_{C}=10mA)$
- 2)Complements the SST2907A/UM2907AU3

Outline



•Inner circuit



Application

AUDIO FREQUENCY SMALL SIGNAL AMPLIFIER

Packaging specifications

Part No.	Package	Package size	Taping code	Reel size (mm)	Tape width (mm)	Basic ordering unit.(pcs)	Marking
SST2222A	SOT-23 (SST3)	2924	T116	180	8	3000	R1P
UM2222AU3	SOT-323 (UMT3)	2021	T106	180	8	3000	R1P

● Absolute maximum ratings (T_a = 25°C)

Pa	arameter	Symbol	Values	Unit
Collector-base voltage		V_{CBO}	75	V
Collector-emitter voltage)	V_{CEO}	40	V
Emitter-base voltage		V_{EBO}	6	V
Collector current		I _C	600	mA
	CCT2222A	P _D *1	200	mW
Power dissipation	SST2222A	P _D *2	350	mW
	UM2222AU3	P _D *1	200	mW
Junction temperature		T _j	150	°C
Range of storage temperature		T _{stg}	-55 to +150	°C

• Electrical characteristics $(T_a = 25^{\circ}C)$

Parameter	Symbol	Conditions	Values			Unit
- arameter	Symbol	Conditions	Min.	Тур.	Max.	Orlit
Collector-base breakdown voltage	BV _{CBO}	I _C = 10μA	75	-	-	V
Collector-emitter breakdown voltage	BV _{CEO}	I _C = 10mA	40	-	ı	V
Emitter-base breakdown voltage	BV _{EBO}	I _E = 10μA	6	-	1	V
Collector cut-off current	I _{CBO}	V _{CB} = 60V	•	1	100	nA
Emitter cut-off current	I _{EBO}	V _{EB} = 3V	-	-	100	nA
Collector-emitter saturation voltage	V _{CE(sat)} 1	I _C = 150mA, I _B = 15mA	-	-	0.3	V
	V _{CE(sat)} 2	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	-	-	1.0	V
Base-emitter saturation voltage	V _{BE(sat)} 1	I _C = 150mA, I _B = 15mA	0.6	-	1.2	V
	V _{BE(sat)} 2	$I_C = 500 \text{mA}, I_B = 50 \text{mA}$	-	-	2.0	V
	h _{FE} 1	$V_{CE} = 10V, I_{C} = 100\mu A$	35	-	-	-
	h _{FE} 2	V _{CE} = 10V, I _C = 1mA	50	-	-	-
DC gurrent gain	h _{FE} 3	V _{CE} = 10V, I _C = 10mA	75	-	-	-
DC current gain	h _{FE} 4	V _{CE} = 1V, I _C = 150mA	50	-	-	-
	h _{FE} 5*2	V _{CE} = 10V, I _C = 150mA	100	-	300	-
	h _{FE} 6*2	V _{CE} = 10V, I _C = 500mA	40	-	-	-
Transition frequency	f _T *2	$V_{CE} = 20V, I_{E} = -20mA$ f = 100MHz		-	-	MHz
Output capacitance	C _{ob}	$V_{CB} = 10V, I_{E} = 0A$ f = 100kHz	-	-	8	pF
Input capacitance	C _{ib}	V _{BE} = 500mV f = 100kHz	-	-	25	pF
Delay time	t _d	V _{CC} ≈ 30V I _C = 150mA	-	-	10	ns
Rise time	t _r	I_{B1} = 15mA, R_L = 200Ω See test circuit	-	-	25	ns
Storage time	t _{stg}	$V_{CC} \approx 30V$ $I_C = 150 \text{mA}$	-	-	225	ns
Fall time	t _f	I_{B1} = 15mA I_{B2} = -15mA, R _L = 200Ω See test circuit	-	-	60	ns

^{*1} Each terminal mounted on a reference land.



^{*2} Pulsed

● Electrical characteristic curves(T_a = 25°C)

Fig.1 Ground Emitter Propagation Characteristics

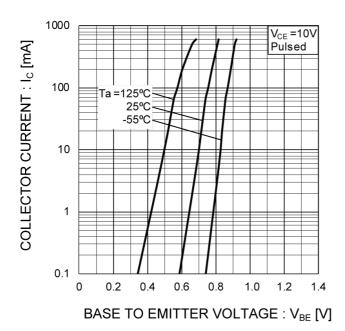
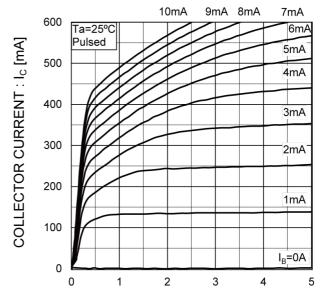


Fig.2 Typical Output Characteristics



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]

Fig.3 DC Current Gain vs. Collector Current (I)

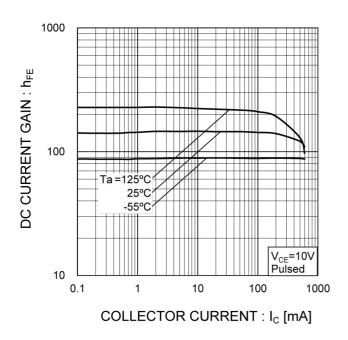
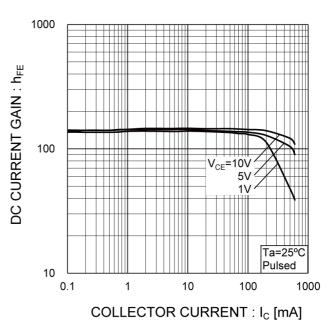


Fig.4 DC Current Gain vs. Collector Current (II)



● Electrical characteristic curves(T_a = 25°C)

Fig.5 Collector-Emitter Saturation Voltage vs. Collector Current (I)

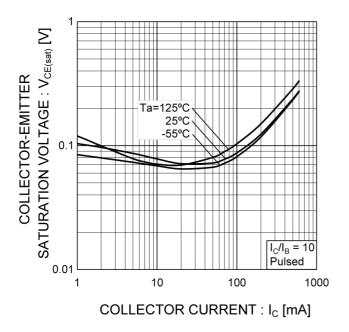


Fig.6 Collector-Emitter Saturation Voltage vs. Collector Current (II)

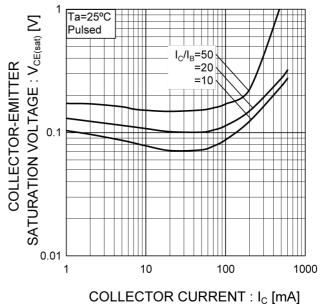


Fig.7 Base-Emitter Saturation Voltage vs. Collector Current

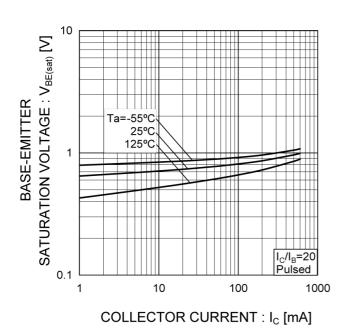
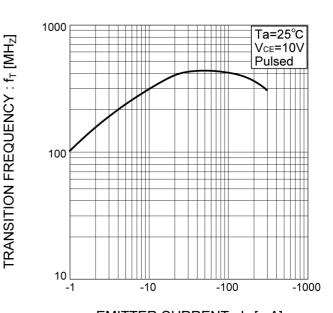


Fig.8 Gain Bandwidth Product vs. Emitter Current



EMITTER CURRENT : IE [mA]

COLLECTOR OUTPUT CAPACITANCE: Cop [pF]

10

Ta=25°C f=100kHz I_E=0A

 $I_{c}=0A$

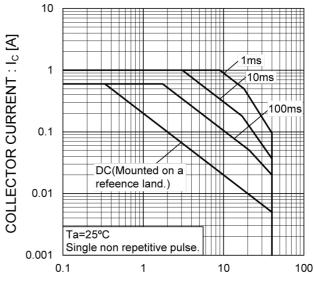
0.1 0.1

● Electrical characteristic curves(T_a = 25°C)

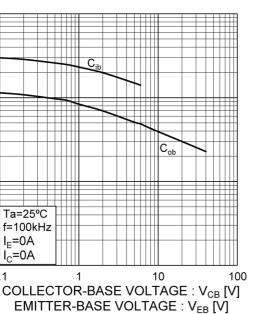
Fig.9 Emitter Input Capacitance vs. Emitter-Base Voltage Collector-Base Voltage

Collector Output Capacitance vs. 100 EMITTER INPUT CAPACITANCE: Gip [pF]

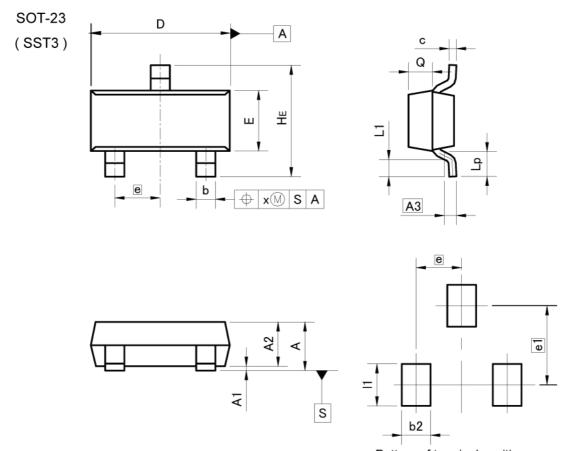
Fig.10 Safe Operating Area



COLLECTOR TO EMITTER VOLTAGE: V_{CE} [V]



Dimensions



Pattern of termi	nal position	areas
[Not a pattern of	of soldering	pads]
	_	

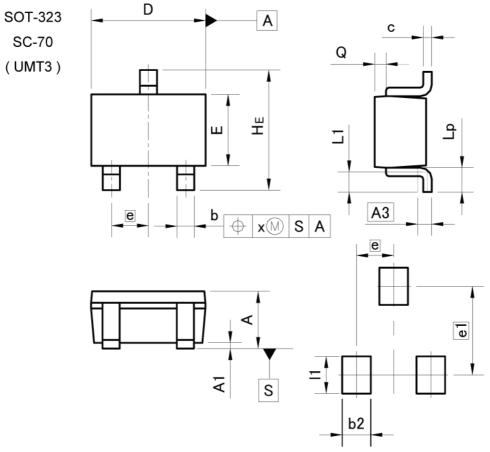
DIM MIL		ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.90	1.20	0.035	0.047
A1	0.00	0.10	0.000	0.004
A2	0.85	1.15	0.033	0.045
A3	0.3	25	0.0	10
b	0.35	0.50	0.014	0.020
С	0.09	0.25	0.004	0.010
D	2.70	3.10	0.106	0.122
E	1.20	1.50	0.047	0.059
е	0.9	95	0.037	
HE	2.20	2.60	0.087	0.102
L1	0.20	00	0.008	_
Lp	0.30	p.=.;	0.012	u=-
Q	0.40	0.60	0.016	0.024
х	-0	0.10	-	0.004

DIM		MILIM	ETERS	INCHES		
		MIN	MAX	MIN	MAX	
b2			0.60	_	0.024	
e1		1.70		0.0	67	
- 11		-3	0.90	-	0.035	

Dimension in mm/inches



Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES
DIM	MIN	MAX	MIN	MAX
Α	0.80	1.00	0.031	0.039
A1	0.00	0.10	0.000	0.004
A3	0.5	25	0.0	10
b	0.25	0.40	0.010	0.016
С	0.10	0.20	0.004	0.008
D	1.90	2.10	0.075	0.083
E	1.15	1.35	0.045	0.053
е	0.	65	0.026	
HE	2.00	2.20	0.079	0.087
L1	0.10	0.40	0.004	0.016
Lp	0.25	0.55	0.010	0.022
Q	0.10	0.30	0.004	0.012
х	_	0.10	_	0.004

DIM MILII		ETERS	INCHES		
		MAX	MIN	MAX	
b2	_	0.50	_	0.020	
e1	1.55		0.0	61	
11	-	0.65	-	0.026	

Dimension in mm/inches



Notice

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JAPAN	USA	EU	CHINA
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CLASSIV	CLASSII	CLASSⅢ	CLASSⅢ

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 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (Exclude cases where no-clean type fluxes is used. However, recommend sufficiently about the residue.); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse, is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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